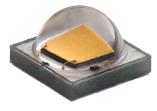
Cree® XLamp® XP-G2 LEDs



PRODUCT DESCRIPTION

The XLamp® XP-G2 LED builds on the unprecedented performance of the original XP-G by increasing lumen output up to 20% while providing a single die LED point source for precise optical control. The XP-G2 LED shares the same footprint as the original XP-G, providing a seamless upgrade path and shortening the design cycle.

XLamp XP-G2 LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED light bulbs, outdoor lighting, portable lighting, indoor lighting and solar-powered lighting.

FEATURES

- Available in white, outdoor white and 80-, 85- and 90-CRI white
- ANSI-compatible chromaticity bins
- Binned at 85 °C
- Maximum drive current: 1500 mA
- Low thermal resistance: 4 °C/W
- Wide viewing angle: 115°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL[®] recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		4	
Viewing angle (FWHM)	degrees		115	
Temperature coefficient of voltage	mV/°C		-1.8	
ESD withstand voltage (HBM per Mil-Std-883D)	V			8000
DC forward current	mA			1500
Reverse voltage	V			5
Forward voltage (@ 350 mA, 85 °C)	V		2.8	3.15
Forward voltage (@ 700 mA, 85 °C)	V		2.9	
Forward voltage (@ 1000 mA, 85 °C)	V		3.0	
Forward voltage (@ 1500 mA, 85 °C)	V		3.1	
LED junction temperature	°C			150

FLUX CHARACTERISTICS (T_{J} = 85 °C)

The following table provides several base order codes for XLamp XP-G2 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family LEDs Binning and Labeling document.

Color	ССТІ	Range	Minimum Luminous Flux @ 350 mA		Calculated Minimum Luminous Flux (Im)** @ 85 °C			Order Code	
	Min. Max.		Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	1.5 A	
			R3	122	138	223	297	402	XPGBWT-L1-0000-00F51
			R4	130	147	237	316	429	XPGBWT-L1-0000-00G51
Cool White	5000 K	8300 K	R5	139	158	254	338	458	XPGBWT-L1-0000-00H51
			S2	148	168	271	360	488	XPGBWT-L1-0000-00J51
			S3	156	177	285	380	515	XPGBWT-L1-0000-00K51
			R2	114	129	208	277	376	XPGBWT-01-0000-00EC2
			R3	122	138	223	297	402	XPGBWT-01-0000-00FC2
	2000 //	5000 K	R4	130	147	237	316	429	XPGBWT-01-0000-00GC2
Outdoor White	3200 K	5300 K	R5	139	158	254	338	458	XPGBWT-01-0000-00HC2
			S2	148	168	271	360	488	XPGBWT-01-0000-00JC2
			S3	156	177	285	380	515	XPGBWT-01-0000-00KC2
			Q5	107	121	195	260	353	XPGBWT-L1-0000-00DE4
		5000 1/	R2	114	129	208	277	376	XPGBWT-L1-0000-00EE4
Noutral W/hite	2700 K		R3	122	138	223	297	402	XPGBWT-L1-0000-00FE4
Neutral White	3700 K	5300 K	R4	130	147	237	316	429	XPGBWT-L1-0000-00GE4
			R5	139	158	254	338	458	XPGBWT-L1-0000-00HE4
			S2	148	168	271	360	488	XPGBWT-L1-0000-00JE4
		К 4300 К	Q4	100	113	182	243	330	XPGBWT-H1-0000-00CE7
			Q5	107	121	195	260	353	XPGBWT-H1-0000-00DE7
	000010		R2	114	129	208	277	376	XPGBWT-H1-0000-00EE7
80-CRI White	2600 K		R3	122	138	223	297	402	XPGBWT-H1-0000-00FE7
			R4	130	147	237	316	429	XPGBWT-H1-0000-00GE7
			R5	139	158	254	338	458	XPGBWT-H1-0000-00HE7

Notes:

 Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 10).

- Typical CRI for Cool White (5000 K 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K 5300 K CCT) is 70.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 700 mA, 1 A and 1.5 A are for reference only.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.



FLUX	CHARACTERISTICS (T _J = 85 °C) - CC	NTINUED

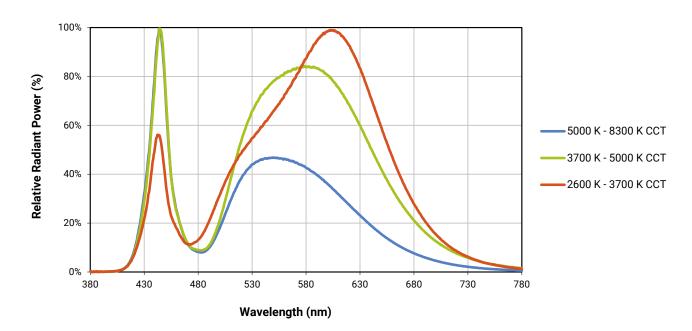
Color	CCT Range		Minimum Luminous Flux @ 350 mA			Calculated Minimum Luminous Flux (Im)** @ 85 °C			Order Code	
Mi	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	1.5 A		
		3700 K	Q4	100	113	182	243	330	XPGBWT-L1-0000-00CE7	
			Q5	107	121	195	260	353	XPGBWT-L1-0000-00DE7	
Warm White	2600 K		R2	114	129	208	277	376	XPGBWT-L1-0000-00EE7	
warm white	2000 K		R3	122	138	223	297	402	XPGBWT-L1-0000-00FE7	
			R4	130	147	237	316	429	XPGBWT-L1-0000-00GE7	
			R5	139	158	254	338	458	XPGBWT-L1-0000-00HE7	
		1600 K 3200 K	P3	73.9	83.8	135	180	244	XPGBWT-P1-0000-008E7	
85-CRI White 2600 K			P4	80.6	91.4	147	196	266	XPGBWT-P1-0000-009E7	
	2600 K		Q2	87.4	99.1	160	213	288	XPGBWT-P1-0000-00AE7	
	2000 K		Q3	93.9	106	172	228	310	XPGBWT-P1-0000-00BE7	
			Q4	100	113	182	243	330	XPGBWT-P1-0000-00CE7	
			Q5	107	121	195	260	353	XPGBWT-P1-0000-00DE7	
		3200 K	P3	73.9	83.8	135	180	244	XPGBWT-U1-0000-008E7	
				P4	80.6	91.4	147	196	266	XPGBWT-U1-0000-009E7
	2600 K		Q2	87.4	99.1	160	213	288	XPGBWT-U1-0000-00AE	
90-CRI White			Q3	93.9	106	172	228	310	XPGBWT-U1-0000-00BE7	
			Q4	100	113	182	243	330	XPGBWT-U1-0000-00CE7	
			Q5	107	121	195	260	353	XPGBWT-U1-0000-00DE7	

Notes:

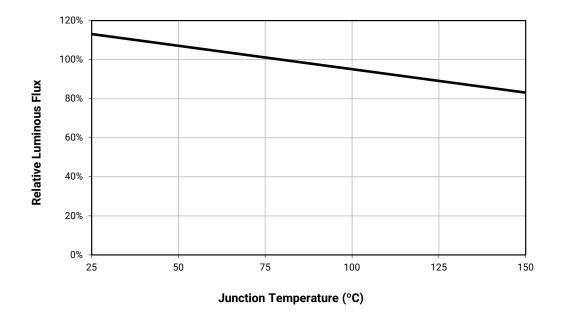
 Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 10).

- Typical CRI for Cool White (5000 K 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K 5300 K CCT) is 70.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 700 mA, 1 A and 1.5 A are for reference only.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.

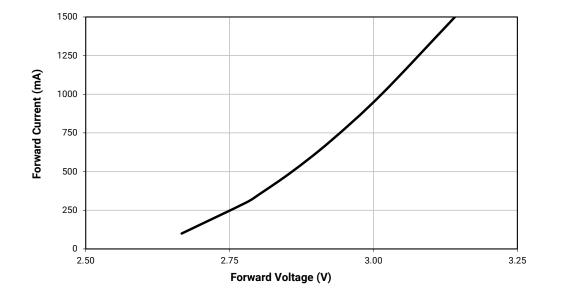
RELATIVE SPECTRAL POWER DISTRIBUTION



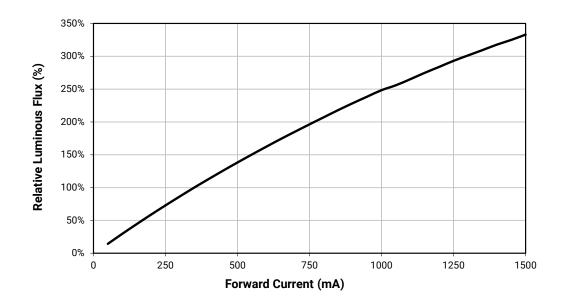
RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)



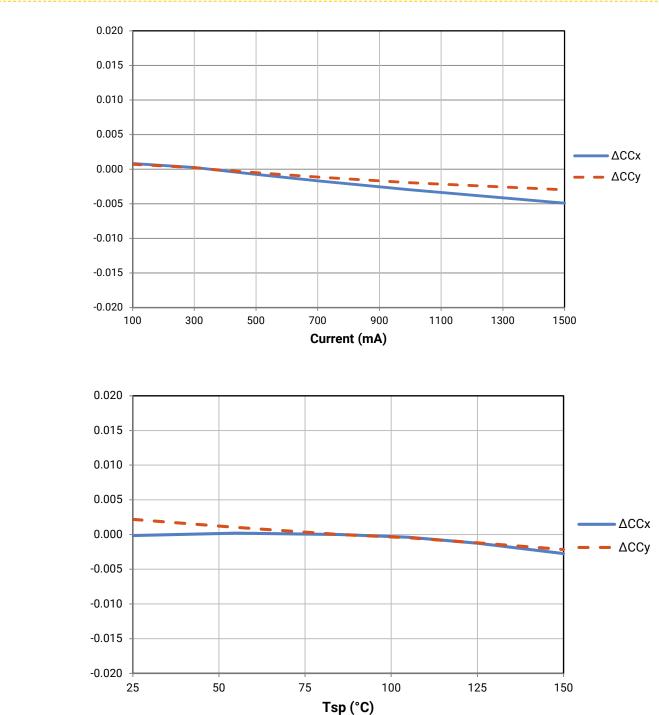
ELECTRICAL CHARACTERISTICS ($T_J = 85 °C$)



RELATIVE FLUX VS. CURRENT (T_{J} = 85 °C)



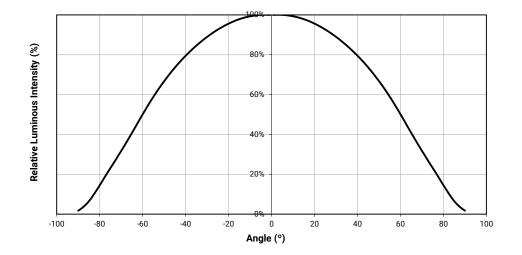




RELATIVE CHROMATICITY VS CURRENT AND TEMPERATURE (WARM WHITE*)

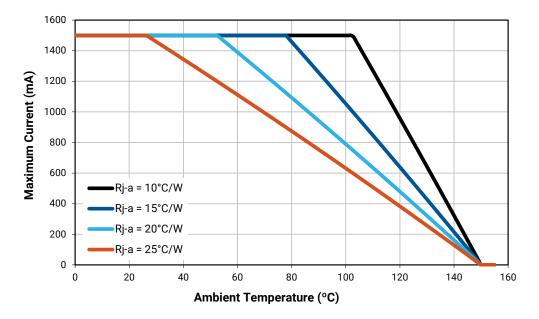
* Warm White XLamp XP-G2 LEDs have a typical CRI of 80.

TYPICAL SPATIAL DISTRIBUTION



THERMAL DESIGN

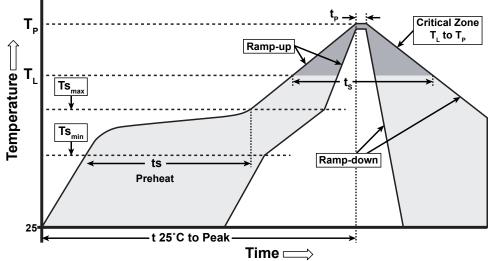
The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-G2 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts $_{max}$ to T $_{p}$)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t_L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-G2 LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of the storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

UL® Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.



NOTES - CONTINUED

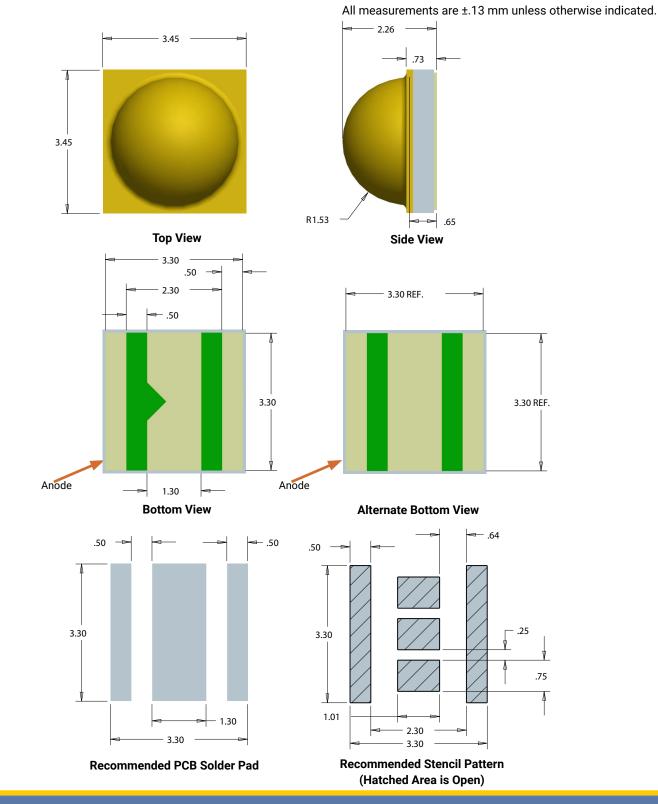
Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

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MECHANICAL DIMENSIONS ($T_A = 25 \degree C$)

Thermal vias, if present, are not shown on these drawings.

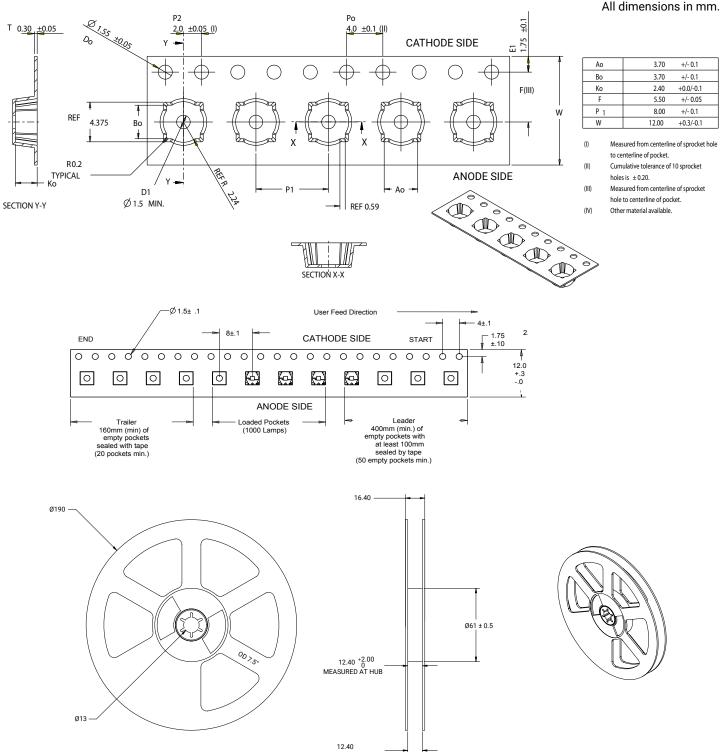


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TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.



MEASURED AT INSIDE EDGE



PACKAGING

